<u>REMARKS</u>

Claims 1-9 and 24-28 are pending. By this Amendment, claim 1 is amended and claims 24-28 are added. No new matter is added.

Applicant thanks Examiner Hine for the indication on page 4 of the Office Action that claims 3-6 recite allowable subject matter. Accordingly, claim 25-28 are added to recite the subject matter indicated as allowable. Specifically, claim 25 recites the features of allowable claim 3 in independent form. Claims 26-28 depends from claim 25 and recite allowable features of claims 4-6, respectively.

Support for the amendment to claim 1 is found, for example, in FIG. 2 of the Disclosure. Support for new claim 24 is found, for example, in paragraph [0021] of the disclosure.

For the following reasons, reconsideration is respectfully requested.

REJECTION UNDER 35 U.S.C. §102:

On page 2 of the Office Action, claims 1, 2, 7, and 9 are rejected under 35 U.S.C. §102(b) as being anticipated by Cho (U.S. Patent Application Publication No. 2002/0043928). The rejection is respectfully traversed.

It is respectfully submitted that the feature of a pixel define layer formed on the substrate and covering one portion of the lower electrode while exposing another portion of the lower electrode, the pixel define layer having a planar upper surface at a second step difference above the substrate, wherein the second step difference of the pixel define layer is not greater than the first step difference of the lower electrode, as defined in claim 1, is patentably distinguishable over the applied reference to Cho.

Specifically, Cho discloses an interlayer insulator 140 having <u>a non-planar upper surface</u> above the substrate 110 rather than a planar upper surface. A portion of the non-planar upper surface has a step difference that is <u>greater than</u> the step difference of the anode electrode 120 (see, for example, paragraph [0024] and FIG. 3F of Cho). Accordingly, claim 1 is patentably distinguishable over the applied reference to Cho.

Claims 2, 7, and 9, which depend from claim 1, are likewise patentably distinguishable over the applied reference for at least the reasons discussed above, and for the additional features they recite. Withdrawal of the rejection is respectfully requested.

REJECTION UNDER 35 U.S.C. §103:

On page 3 of the Office Action, claim 8 is rejected under 35 U.S.C. §103(a) as being unpatentable over Cho, in view of Arnold et al. (U.S. Patent No. 7,038,373). The rejection is respectfully traversed.

As discussed above, claim 1 is patentably distinguishable over the Cho reference. Claim 8, which depends from claim 1, is also patentably distinguishable over the applied references to Cho and Arnold for at least the reasons discussed above, and for the additional features it recites. Withdrawal of the rejection is respectfully submitted.

ALLOWABLE SUBJECT MATTER:

On page 4 of the Office Action, claims 3-6 are indicated as reciting allowable subject matter.

NEW CLAIMS:

Claim 24 is patentable over the applied references for at least its dependence from claim 1 and for its added features.

Claim 25-28 are allowable since they recite the subject matter indicated as allowable. Specifically, claim 25 recites the features of allowable claim 3 in independent form. Claims 26-28 depend from claim 24 and recite allowable features of claims 4-6, respectively.

CONCLUSION:

There being no further outstanding objections or rejections, it is submitted that the application is in condition for allowance. An early action to that effect is courteously solicited.

Finally, if there are any formal matters remaining after this response, the Examiner is requested to telephone the undersigned to attend to these matters.

Application No. 10/820,845

If there are any additional fees associated with filing of this Amendment, please charge the same to our Deposit Account No. 503333.

Respectfully submitted,

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